

F1S THRU F7S

SURFACE MOUNT FAST RECOVERY RECTIFIERS



VOLTAGE: 50~1000 Volts	CURRENT: 1.0 Amperes	SOD-323	Marking and Polarity
FEATURES <ul style="list-style-type: none"> ■ Glass passivated chip junction ■ Fast recovery time ■ Low Forward Voltage Drop for high efficiency ■ Low leakage current for high reliability ■ High forward surge capability for high reliability 			
MECHANICAL DATA <ul style="list-style-type: none"> ■ Terminals: Plated Leads Solderable per MIL-STD-202, Method 208 ■ Mounting Position: Any ■ Lead Free: Lead Free Finish, RoHS Compliant ■ Weight: App. 0.0041 grams (0.00014 ounce) 		Remark: <ul style="list-style-type: none"> ①. NH=niuhang trademark ②. xR=Modle,x=1,2,3,4,5,6,7 ③. White band denotes cathode 	
TYPICAL APPLICATIONS <ul style="list-style-type: none"> ■ For use in high frequency inverters ,AC/DC converters, DC/DC converter,LED driver etc. applications 			

Maximum Ratings (Ratings at 25°C ambient temperature unless otherwise specified.)

Parameter	Symbol	F1S	F2S	F3S	F4S	F5S	F6S	F7S	Unit
Marking	Code	1R	2R	3R	4R	5R	6R	7R	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V_{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current(see fig.1)	$I_{F(AV)}$	1.0							A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method at rated TL)(see fig.5)	I_{FSM}	15							A
Current Squared Time Per Diode(t<8.3ms)	I^2t	0.93							A ² sec

Electrical Characteristics (Ratings at 25°C ambient temperature unless otherwise specified).

Parameter	Test Conditions		Symbol	F1S	F2S	F3S	F4S	F5S	F6S	F7S	Unit
Maximum instantaneous forward voltage (see fig.2) (Note 1)	$T_A=25^\circ C$	$I_F=1.0 A$	V_F	1.3							V
Maximum instantaneous reverse current at rated DC blocking voltage (see fig.3)(Note 1)	$T_A=25^\circ C$	$V_R=V_{RRM}$	I_R	5							uA
	$T_A=125^\circ C$	$V_R=80\%*V_{RRM}$		200							
Maximum Reverse Recovery Time	$I_F=0.5A, I_R=1.0A, I_{RR}=0.25A$		T_{RR}	150			250	500		ns	
Typical junction capacitance(see fig.4)	4V,1MHz		C_J	8			5			pF	

Thermal Characteristics (Ratings at 25°C ambient temperature unless otherwise specified)

Parameter	Symbol	F1S	F2S	F3S	F4S	F5S	F6S	F7S	Unit
Operating junction	T_J	-55 to 150							°C
Storage temperature range	T_{STG}	-55 to 150							
Typical thermal resistance (Note 2)	R_{BJA}	70							°C/W
	R_{BJC}	20							

Note: 1.Pulse width < 300 uS, Duty cycle < 2%

2.P.C.B. mounted with 0.1"x0.1"(2.54 x 2.54 mm) copper pad areas

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RATING AND CHARACTERISTIC CURVES

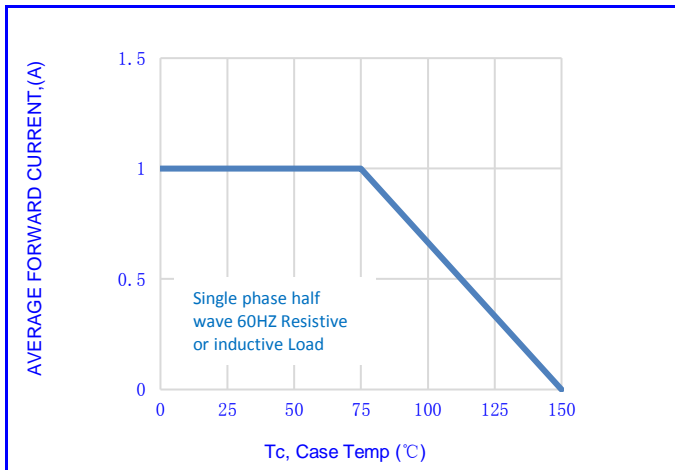


Fig.1- FORWARD CURRENT DERATING CURVE

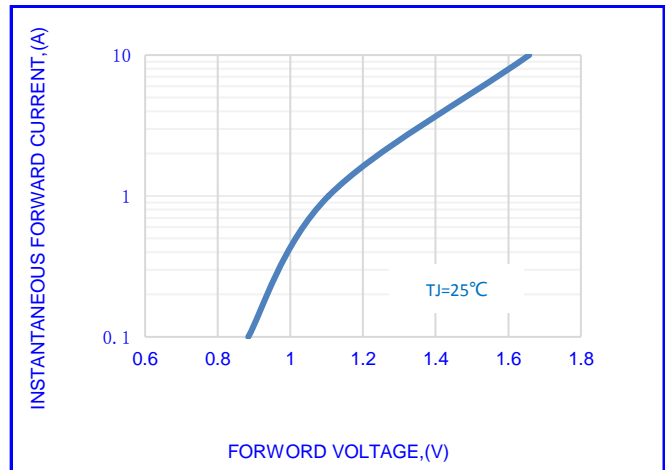


Fig.2-TYPICAL INSTANTANEOUS FORWARD

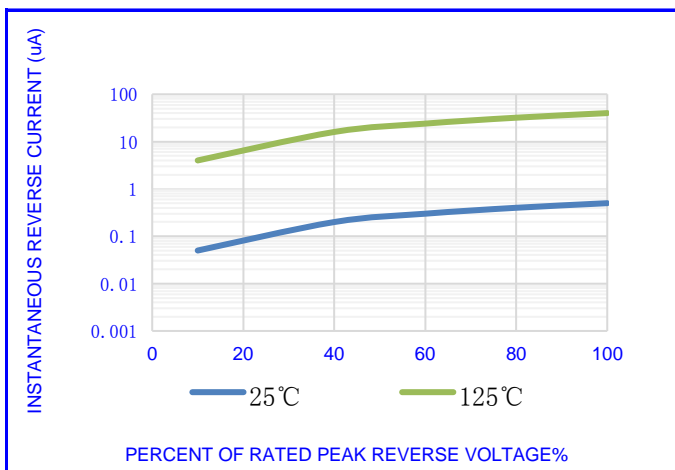


Fig.3-TYPICAL REVERSE CHARACTERISTICS

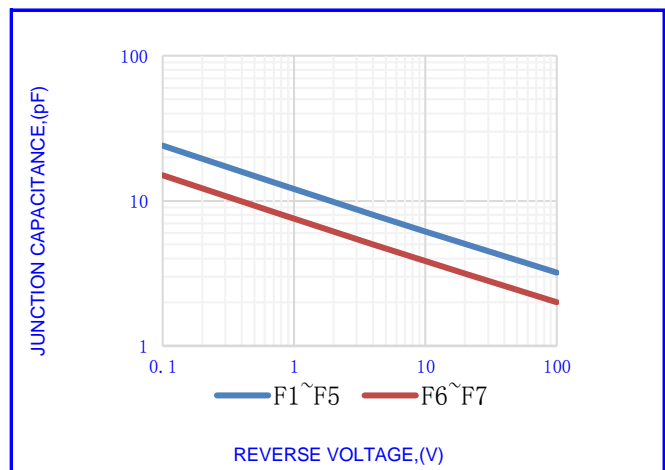


Fig.4- TYPICAL JUNCTION CAPACITANCE

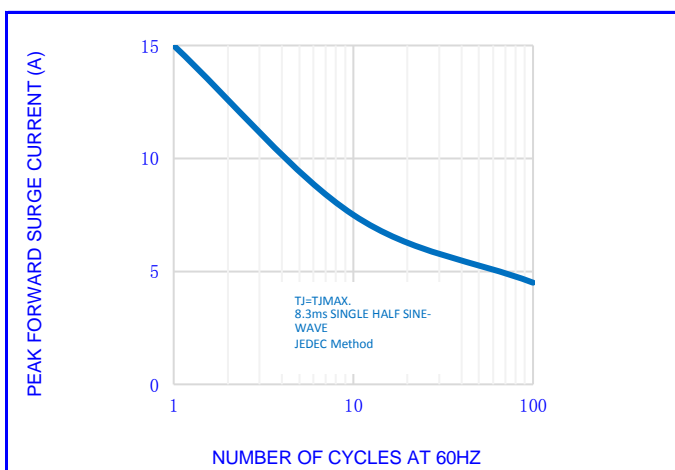


Fig.5-MAX. NON-REPETITIVE SURGE CURRENT

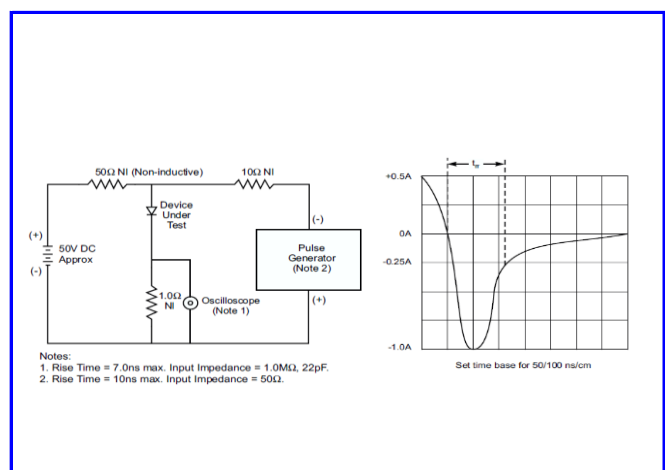


Fig.6-REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT

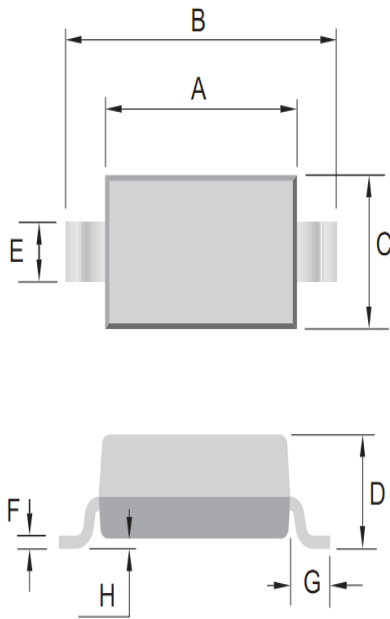
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OUTLINE DRAWINGS

SOD-323

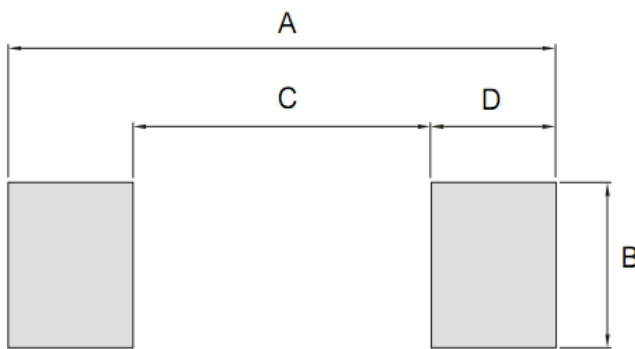


OUTLINE DIMENSIONS

Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.600	-	1.800	0.063	-	0.071
B	2.400	-	2.700	0.094	-	0.106
C	1.200	-	1.400	0.047	-	0.055
D	-	-	1.000	-	-	0.039
E	0.250	-	0.350	0.010	-	0.014
F	0.080	-	0.150	0.003	-	0.006
G	-	0.475	-	-	0.019	-
H	-	-	0.120	-	-	0.005

RECOMMENDED LAYOUT DRAWINGS

SOD-323



RECOMMENDED MOUNTING PAD DIMENSIONS

Dim.	Milimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	--	2.900	--	--	0.114	--
B	--	0.500	--	--	0.020	--
C	--	1.440	--	--	0.057	--
D	--	0.730	--	--	0.029	--

PACKING INFORMATION

SOD-323

Package Method	Reel Size (mm)	Quantity (pcs/reel)	Inner Box Size LxWxH(mm)	Quantity (pcs/Inner Box)	Carton Size LxWxH(mm)	Quantity (pcs/carton)
Tape Reel	Φ180	3000	185x185x90	21000	400x400x300	252000

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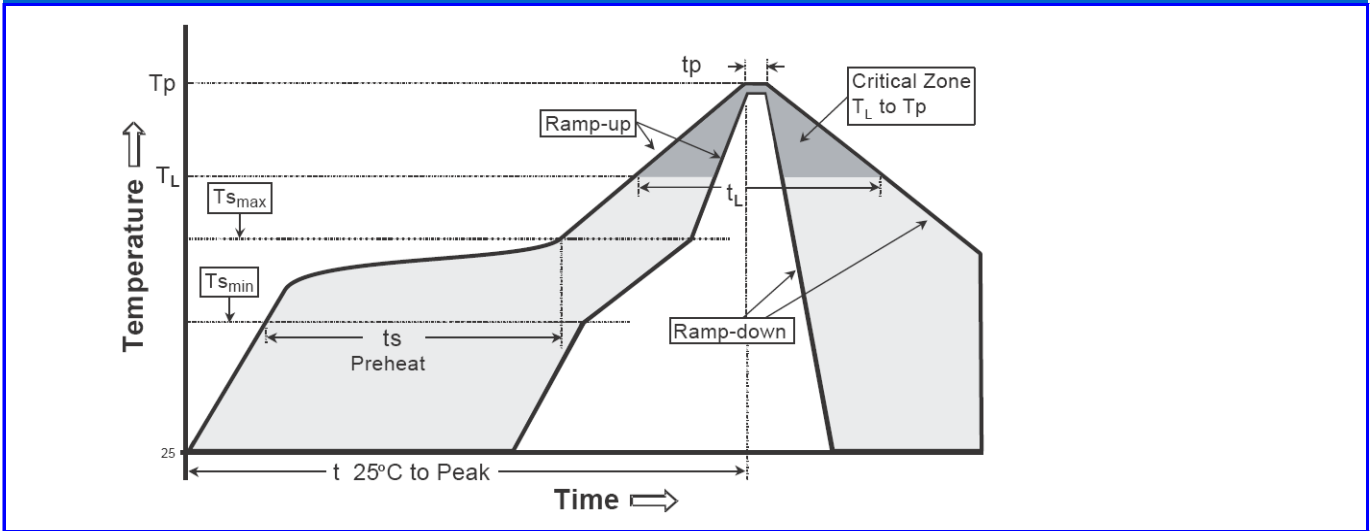
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Recommended wave soldering condition

Product	Peak Temperature	Soldering Time
Pb-free devices	260 +0/-5 °C	5 +1/-1 seconds

Recommended temperature profile for IR reflow



Profile feature	Sn-Pb eutectic Assembly	Pb-free Assembly
Average ramp-up rate (Tsmmax to Tp)	3°C/second max.	3°C/second max.
Preheat -Temperature Min(TS min) -Temperature Max(TS max) -Time(ts min to ts max)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
Time maintained above: -Temperature (TL) - Time (tL)	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature(TP)	240 +0/-5 °C	260 +0/-5 °C
Time within 5°C of actual peak temperature(tp)	10-30 seconds	20-40 seconds
Ramp down rate	6°C/second max.	6°C/second max.
Time 25 °C to peak temperature	6 minutes max.	8 minutes max.

Note : All temperatures refer to topside of the package, measured on the package body surface.

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